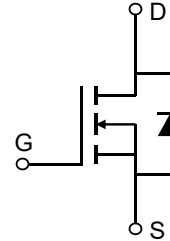


Description

Features

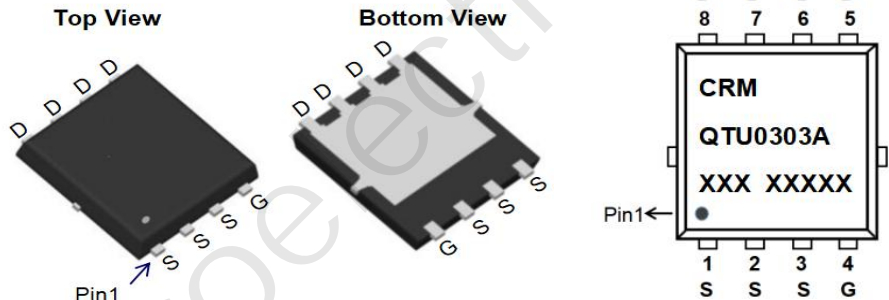
- 25V, 62A
- $R_{DS(ON)}$ Typ = 3.4mΩ @ $V_{GS} = 4.5V$
- $R_{DS(ON)}$ Typ = 4.3mΩ @ $V_{GS} = 2.5V$
- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free
- 100% UIS TESTED!
- 100% ΔV_d s TESTED!



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

| Device | Marking | Package | Outline | Reel Size | Reel (pcs) | Per Carton (pcs) |
|-------------|-------------|----------------|---------|-----------|------------|------------------|
| CRMQTU0303A | CRMQTU0303A | PDFN3.3x3.3-8L | TAPING | 13" | 5000 | 50000 |

Absolute Maximum Ratings (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Value | Units |
|-----------------|---|---------------------------|-------|
| V_{DS} | Drain-to-Source Voltage | 25 | V |
| V_{GS} | Gate-to-Source Voltage | ±12 | V |
| I_D | Continuous Drain Current | $T_C = 25^\circ\text{C}$ | 62 |
| | | $T_C = 100^\circ\text{C}$ | 37.2 |
| I_{DM} | Pulsed Drain Current ⁽¹⁾ | 248 | A |
| E_{AS} | Single Pulsed Avalanche Energy ⁽²⁾ | 81 | mJ |
| P_D | Power Dissipation | $T_C = 25^\circ\text{C}$ | 28 |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 4.4 | °C/W |
| T_J, T_{STG} | Junction & Storage Temperature Range | -55 to 150 | °C |

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--|--|---|---------------------------------------|------|------|------|
| Off Characteristics | | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | I _D = 250μA, V _{GS} = 0V | 25 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 25V, V _{GS} = 0V | - | - | 1.0 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{DS} = 0V, V _{GS} = ±12V | - | - | ±100 | nA |
| On Characteristics | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 250μA | 0.4 | 0.7 | 1 | V |
| R _{DS(ON)} | Static Drain-Source ON-Resistance ⁽³⁾ | V _{GS} = 4.5V, I _D = 20A | - | 3.4 | 4.4 | mΩ |
| | | V _{GS} = 2.5V, I _D = 10A | - | 4.3 | 5.6 | mΩ |
| Dynamic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} = 0V, V _{DS} = 10V, f = 1MHz | - | 3280 | - | pF |
| C _{oss} | Output Capacitance | | - | 362 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | | - | 298 | - | pF |
| Q _g | Total Gate Charge | V _{GS} = 0 to 10V V _{DS} = 15V, I _D = 30A | - | 42 | - | nC |
| Q _{gs} | Gate Source Charge | | - | 9 | - | nC |
| Q _{gd} | Gate Drain("Miller") Charge | | - | 10 | - | nC |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-On DelayTime | V _{GS} = 10V, V _{DD} = 15V I _D = 30A, R _{GEN} = 3Ω | - | 9 | - | ns |
| t _r | Turn-On Rise Time | | - | 15 | - | ns |
| t _{d(off)} | Turn-Off DelayTime | | - | 36 | - | ns |
| t _f | Turn-Off Fall Time | | - | 11 | - | ns |
| Drain-Source Diode Characteristics and Max Ratings | | | | | | |
| I _S | Maximum Continuous Drain to Source Diode Forward Current | V _{GS} = 0V, I _S = 10A | - | - | 62 | A |
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 248 | A |
| V _{SD} | Drain to Source Diode Forward Voltage | | - | - | 1.2 | V |
| trr | Body Diode Reverse Recovery Time | | - | 11 | - | ns |
| Qrr | Body Diode Reverse Recovery Charge | | I _F = 20A, di/dt = 100A/us | - | 2.5 | - |

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
 2. E_{AS} condition: Starting $T_J = 25^\circ\text{C}$, $V_{DD} = 10\text{V}$, $V_G = 10\text{V}$, $R_G = 25\Omega$, $L = 0.5\text{mH}$, $I_{AS} = 18\text{A}$
 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$.

Test Circuit



Figure 1: Gate Charge Test Circuit & Waveform



Figure 2: Resistive Switching Test Circuit & Waveform

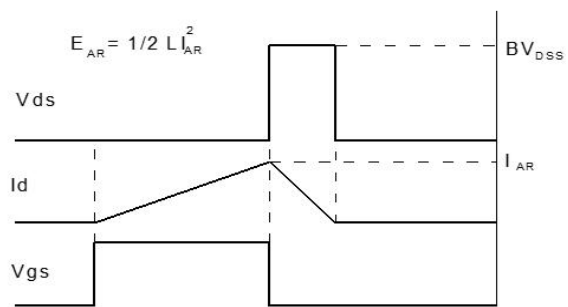
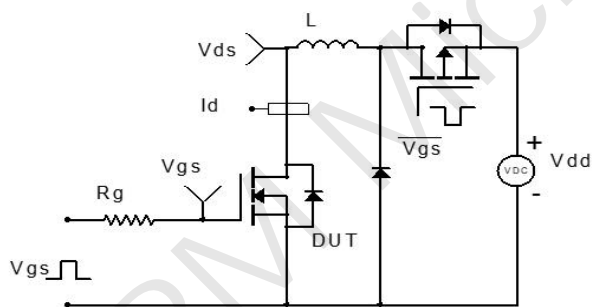
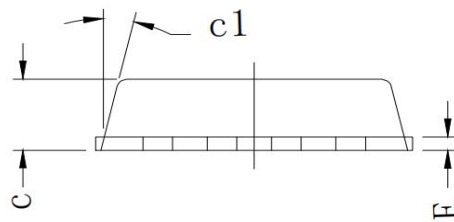
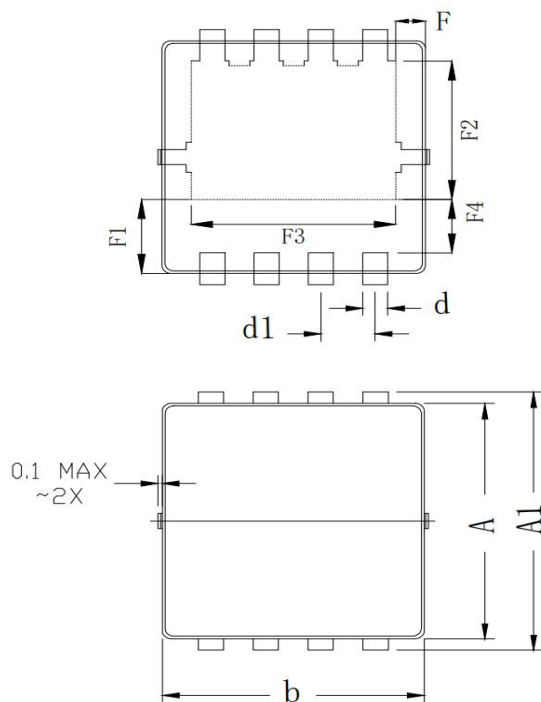


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform



Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(PDFN3.3x3.3-8L)




| COMMON DIMENSION (MM) | | | |
|-----------------------|-----------------|-------|-------|
| PKG | PDFN 3.3×3.3-8L | | |
| SYMBOL | MIN | TYP | MAX |
| A | 3.070 | 3.100 | 3.130 |
| A1 | 3.300 | 3.400 | 3.500 |
| b | 3.070 | 3.100 | 3.130 |
| c | 0.770 | 0.800 | 0.830 |
| c1 | — | 13° | — |
| d | 0.275 | 0.300 | 0.325 |
| d1 | 0.625 | 0.650 | 0.675 |
| E | 0.144 | 0.152 | 0.160 |
| F | 0.300 | 0.325 | 0.350 |
| F1 | 0.960 | 0.985 | 1.010 |
| F2 | 1.775 | 1.800 | 1.825 |
| F3 | 2.425 | 2.450 | 2.475 |
| F4 | 0.660 | 0.685 | 0.710 |

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